Prosperity Dielectrics Co., Ltd.

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Date: 2022/09/30

APPROVAL SHEET

Product Name: High Voltage Multilayer Ceramic Chip Capacitors

Part No. : FA55X104M102EFG

Description: Size 2220, X7R, 100nF, ±20%, 250VAC

PREPARED BY	APPROVED BY
THIT DIFFERENCE	ICCO ID ALL
	103 001

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SPECIFICATION

FOR

Product Name: High Voltage Multilayer Ceramic Chip Capacitors

Part No. : FA55X104M102EFG

Description: Size 2220, X7R, 100nF, ±20%, 250VAC

SPEC. No.: FA-018-002-01

DATE: 2022/09/30

DRAWN BY	CHECEKED BY	APPROVED BY	
Jane Hsiao	Yvens Chou	Jason Lin	

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1. INTRODUCTION

PDC FA Series green type capacitors are manufactured by using environmental friendly material without lead or cadmium. These capacitors feature series connection of multi-layer capacitor units in a MLCC to realize high voltage performance. This special design can distribute voltage gradients throughout the entire capacitor, so as to prevent short circuit failure.

This series is no safety approval.

This series refer to the Electrical Appliance and Material Safety Law of Japan for general purpose.

Do not use these products in any automotive power train or safety equipment including battery chargers for electric vehicles and plugin hybrids

2. FEATURES

- a. High reliability and stability.
- b. Small size and high capacitance.
- c. RoHS compliant.

3. APPLICATIONS

- a. Modem.
- b. Facsimile.
- c. Telephone.
- d. Other electronic equipment for lighting or surge protection and isolation.
- e. Commercial power supplies.

4. HOW TO ORDER

<u>FA</u>	<u>55</u>	X	<u>104</u>	<u>K</u>	<u>102</u>	<u>E</u>	<u>E</u>	<u>G</u>
PDC Family	Size	Dielectric	Capacitance	Tolerance	Reference Voltage	Packaging	Thickness	Customer Code
Table 1	Table 2	Table 3	Table 4	Table 5	Table 6	Table 7	Table 8	Table 9

Table 1	PDC Family
Code	Description
FA	AC voltage application product
	10c2 17 D

Table 6		Reference Voltage				
Code	Description	Code	Description	Code	Description	
102	250Vac					
TV(C)	1/2					

Tab	le 2	Size				
Code	De	scription	Code	Description	Code	Description
55	2220	(5750)				

Table 7	F	Packaging Type						
Code	Description	Code	Description					
В	Bulk	E	Embossed Tape					

Table 3	Dielectric Material Characteristics				
Code	Description	Code	Description		
N	C0G	Х	X7R		

Tabl	le 8	Thickness Description				
Code	Des	cription	Code	Description	Code	Description
С	1.25±0	0.10 mm	Е	1.60±0.20 mm	G	2.50±0.30 mm
D	1.40±0	0.15 mm	F	2.00±0.20 mm	Н	2.80±0.30 mm

Table	4	Capacitance Rule Code					
Code		Description	Code	Description			
0R5		0.5pF	104	104=10x10 ⁴ =100nF			

Table 9	Customer Code					
Code	Description	Code	Description			
G	RoHS Compliant	Q	Surface Coating			

Tabl	e 5	Tolerance					
Code	Description	Code	Description	Code	Description		
D	±0.50 pF	G	±2 %	K	±10 %		
F	±1 %	J	±5 %	М	±20 %		

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5. EXTERNAL DIMENSIONS

Size Inch (mm)	2220(5750)	L
L (mm)	5.70±0.50	Ţ
W (mm)	5.00±0.50	W
Code / T(mm)	F / 2.00±0.20	←→ M _B
M _B min.(mm) 0.60±0.30		Fig. 5.1 The outline of MLCC

6. GENERAL ELECTRICAL DATA

Dielectric	X方は X7R	
Size	2220	
Rated voltage	250Vac	
Capacitance range	100nF	
Capacitance tolerance	M(±20%)	
Tan δ	PASSIVE SYSTEM ALLIANCE 2 \$2.5%	
Capacitance & Tan δ Test condition	Measured at the condition of 30~70% related humidity for 25°C at ambient temperature Preconditioning for Class II MLCC: Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 24±2 hours before measurement Apply 1.0±0.2Vrms, 1.0KHz±10%, at 25°C ambient temperature	
Insulation resistance	≥10GΩ or RxC≥100Ω-F, whichever is smaller	
Operating temperature	-55°C to +125°C	
Temperature coefficient	±15%	
Termination	Cu/Ni/Sn (lead-free termination)	

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7. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condit		Requirem	ents	
1.	Visual examination and Dimensions		* No remarkable defect. * Dimensions to confirm to individual specification sheet.			
2.	Capacitance		* Capacitance is within specified tolerance.			
3.	Q/D.F. (Dissipation Factor)	* Class II : 1.0±0.2Vrms, 1KHz±10	%.	Dielectric Class II (X7R)	Rated Vol. (V) ≥50	Q/D.F. D.F.≤2.5%
4.	Temperature Coefficient		ng Temp. C at 25°C	T.C. X7R	Capacitano ±1	ce Change 5%
5.	Voltage proof (Dielectric Strength)	* To apply voltage : 10000pF min. : AC575V(r.m.s.). less than 10000pF : AC1500V(r.r * Duration : 60 sec. * The charge current shall not exce	* No evidence of damage or flash over during test.			
6.	Insulation Resistance	Rated Apply Char Vol.(V) Voltage Curro >500 500Vdc ≤50r	ent Time	Dielectric Class II (X7R)	≥10GΩ or R	ements xC≥100Ω-F, is smaller
7.	Solderability	* Solder temperature : 245±5°C. * Dipping time : 2.0±0.5 sec. * T5% min. coverage of all metalize			ed area.	
8.	Resistance to Soldering Heat	* Solder temperature : 260±5°C. * Dipping time : 10±1 sec. * Preheating : 120 to 150°C for 1 n immerse the capacitor in a eutec * Before initial measurement (Clas +0/-10°C for 1 hr and then set for temp. * Measurement to be made after k temperature for 48±4 hrs (Class I	* Cap. change : እ * D.F. : X7R≤100	o remarkable dam (7R within ±7.5%. % of initial require initial requirement	ment.	
9.	Temperature Cycle	* Conduct the five cycles according to the temperatures and time. Step Temp.(°C) Time(min.) 1 Min. operating temp. +0/-3 30±3 2 Room temp. 2~3 3 Max. operating temp. +3/-0 30±3 4 Room temp. 2~3 * Measurement to be made after keeping at room temperature for 48±4 hrs (Class II). * Appearance : No remarkable damage. * Cap. change : X7R within ±7.5%. * D.F. : X7R≤150% of initial requirement. * I.R. : ≥100% of initial requirement.				

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7. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requirements
10.	Humidity (Damp Heat) Steady State	* Test temp.: 40±2°C. * Humidity: 90~95% RH. * Test time: 500 +24/-0hrs. * Measurement to be made after keeping at room temp. for 48±4 hrs (Class II).	* Appearance : No remarkable damage. * Cap. change : X7R within ±15%. * D.F. : X7R≤200% of initial requirement. * I.R. : ≥1GΩ or RxC≥50Ω-F, whichever is smaller.
11.	Humidity (Damp Heat) Load	* Test temp.: 40±2°C. * Humidity: 90~95% RH. * Test time: 500 +24/-0hrs. * Applied voltage: 250Vac. * Measurement to be made after keeping at room temp. for 48±4 hrs (Class II).	* Appearance : No remarkable damage. * Cap. change : X7R within ±15%. * D.F. : X7R≤200% of initial requirement. * I.R. : ≥500MΩ or RxC≥25Ω-F, whichever is smaller.
13.	High Temperature Load (Endurance)	* Test temp.: 125±3°C. * Test time: 1000 +48/-0 hrs for Cap.≥103. 1500 +48/-0 hrs for Cap.<103. * Applied voltage: 300Vac for Cap.≥103 (Once every hour the voltage shall be increased to 1000Vrms for 0.1 sec.). 500Vac for Cap.<103. * Measurement to be made after keeping at room temp. for 48±4 hrs (Class II).	* Appearance : No mechanical damage. * Cap. change : X7R within ±20%. * D.F.: X7R≤200% of initial requirement. * I.R.: ≥1GΩ.
14.	Resistance to Flexure of Substrate	* Capacitors mounted on a substrate. The board shall be bent 1mm with a rate of 1mm/sec.	* No remarkable damage. * Cap. change: X7R within ±12.5%. (This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test)

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7. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requirements
15.	Adhesive Strength of Termination	* Capacitors mounted on a substrate. A force of 10N applied perpendicular to the place of substrate and parallel the line joining the center of terminations for 10±1 sec. Pressurizing force Capacitor P.C. Board	* No remarkable damage or removal of the terminations.
16.	Vibration	* Reflow solder the capacitors on P. C. Board before test. * Vibration frequency: 10~55 Hz/min. * Total amplitude: 1.5mm. * Repeat the conditions for 2 hours each in 3 perpendicular directions. * Measurement to be made after keeping at room temp. for 48±4 hrs (Class II).	* No remarkable damage. * Cap. change and Q/D.F. : To meet initial spec.



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8. PACKAGE DIMENSION AND QUANTITY

8.1. PACKAGE QUANTITY

Size	Thickness	Pape	r tape	Plastic tape	
Size	(mm)	7" reel	13" reel	7" reel	13" reel
2220(5750)	2.00±0.20	-	-	1k	

8.2. EMBOSSED TAPE DIMENSIONS

Size	2220	
Chip Thickness	2.00±0.20	
A_0	<5.80	Po →
B ₀	<6.50	
Т	0.30±0.10	
K₀	<3.10	
W	12.00±0.20	F 50 f
P ₀	4.00±0.10	
10xP₀	40.00±0.20	
P ₁	8.00±0.10	
P ₂	2.00±0.05	
D_0	1.50+0.10/-0	D ₁ P ₁ 5°
D ₁	1.50±0.10	
Е	1.75±0.10 💆	Į Ko
F	5.50±0.05	
Unit:	mm \	Fig. 8.1 The dimension of plastic tape

8.3. REEL DIMENSIONS

Reel size	7"	O'LELECTRI .
С	13.0 +0.5/-0.2	
W ₁	8.4 +1.5/-0	CNA
Α	178.0 ±0.10	
N	60.0 +1.0/-0	Fig. 8.2 The dimension of reel

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9. APPLICATION NOTES

STORAGE

To prevent the damage of solderability of terminations, the following storage conditions are recommended:

Indoors under 5 ~ 40°C and 20% ~ 70% RH.

No harmful gases containing sulfuric acid, ammonia, hydrogen sulfide or chlorine.

Packaging should not be opened until the capacitors are required for use. If opened, the pack should be re-sealed as soon as is practicable. Taped product should be stored out of direct sunlight, which might promote deterioration in tape or adhesion performance. The product is recommended to be used within 12 months after shipment and checked the solderability before use.

HANDLING

Chip capacitors are dense, hard, brittle, and abrasive materials. They are liable to suffer mechanical damage, in the form of cracks or chips. Chip Capacitors should be handled with care to avoid contamination or damage. To use vacuum or plastic tweezers to pick up or plastic tweezers is recommended for manual placement. Tape and reeled packages are suitable for automatic pick and placement machine.

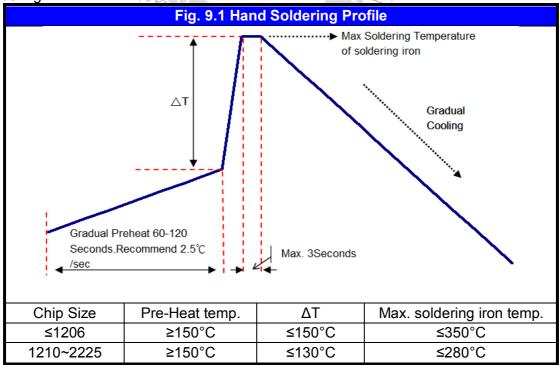
PREHEAT

In order to minimize the risk of thermal shock during soldering, a carefully controlled preheat is required. The rate of preheat should not exceed 3°C per second.

SOLDERING

Use mildly activated rosin fluxes do not use activated flux. The amount of solder in each solder joint should be controlled to prevent the damage of chip capacitors caused by the stress between solder, chips, and substrate.

a.) Hand soldering:



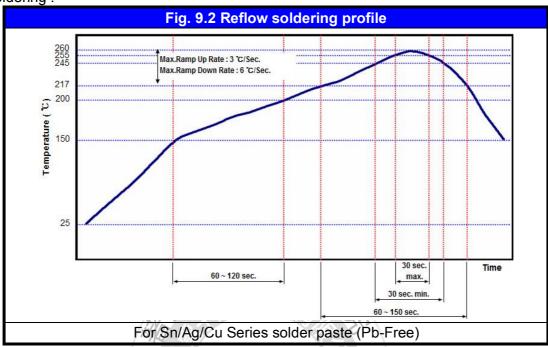
- * Soldering iron tip diameter ≤1.0 mm and wattage max. 20W.
- * The Capacitors shall be pre-heated and that the temperature gradient between the devices and the tip of the soldering iron.
- * The required amount of solder shall be melted on the soldering tip.
- * The tip of iron should not contact the ceramic body directly.
- * The Capacitors shall be cooled gradually at room temperature after soldering.
- * Forced air cooling is not allowed.

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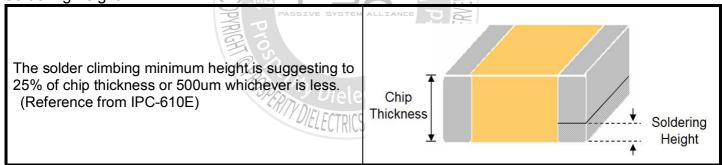
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9. APPLICATION NOTES

b.) Reflow soldering:



Soldering height:



COOLING

After soldering, cool the chips and the substrate gradually to room temperature. Natural cooling in air is recommended to minimize stress in the solder joint.

CLEANING

All flux residues must be removed by using suitable electronic-grade vapor-cleaning solvents to eliminate contamination that could cause electrolytic surface corrosion. Good results can be obtained by using ultrasonic cleaning of the solvent. The choice of the proper system is depends upon many factors such as component mix, flux, and solder paste and assembly method. The ability of the cleaning system to remove flux residues and contamination from under the chips is very important.

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NMC0402X7R392K50TRPF NMC0603NPO201J50TRPF NMC0603NPO330G50TRPF NMC0603NPO331F50TRPF

NMC0603X5R475M6.3TRPF NMC0603X7R333K16TRPF NMC0805NPO220J100TRPF NMC0805NPO820J50TRPF

NMC1206X7R102K50TRPF NMC1206X7R106K10TRPLPF NMC-H0805X7R472K250TRPF C1608C0G2A221J C1608X7R1E334K

C2012C0G2A472J 2220J2K00562KXT CCR06CG153FSV CDR33BX104AKUR CDR33BX683AKUS CGA3E1X7R1C684K

CL10C0R8BB8ANNC M55342H06B20G0R-T/R C1005X5R0G225M C2012X7R2E223K C3216C0G2J272J D55342E07B35E7R-T/R

CDR34BX563BKUS CDR34BX563BKWS NMC0402NPO220F50TRPF NMC0402X7R562J25TRPF NMC0603NPO102J25TRPF

NMC1206X7R332K50TRPF NMC-P1206X7R104K250TRPLPF 726632-1 CGA6M3X7R1H225K CGA5L2X7R2A105K

CGA3E2X8R1H223K CDR33BX823AKUR\M500 CDR33BP132BJUR CDR35BX474AKUR\M500 CDR35BX104BKUR\M500